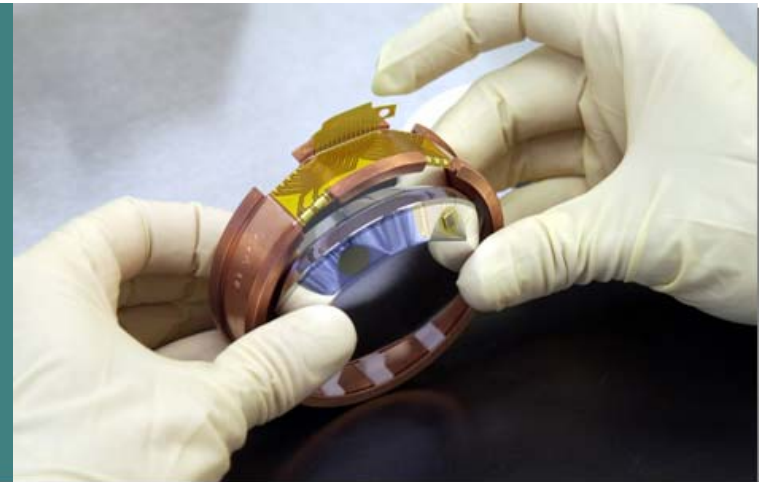
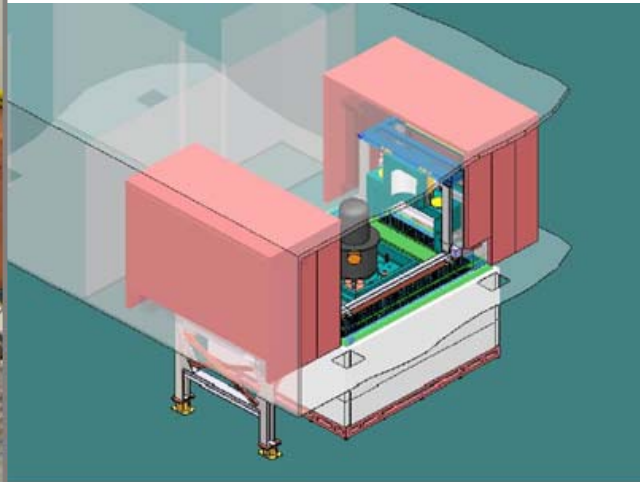




Surface event identification in the EDELWEISS Ge bolometers

Xavier-François Navick (CEA Dapnia)

LRT2006 - Aussois October 06



Outlines

- Introduction
- EDELWEISS's ionization-heat detectors
- Surface events in EDELWEISS-I
- Developments to suppress the surface events

Edelweiss collaboration

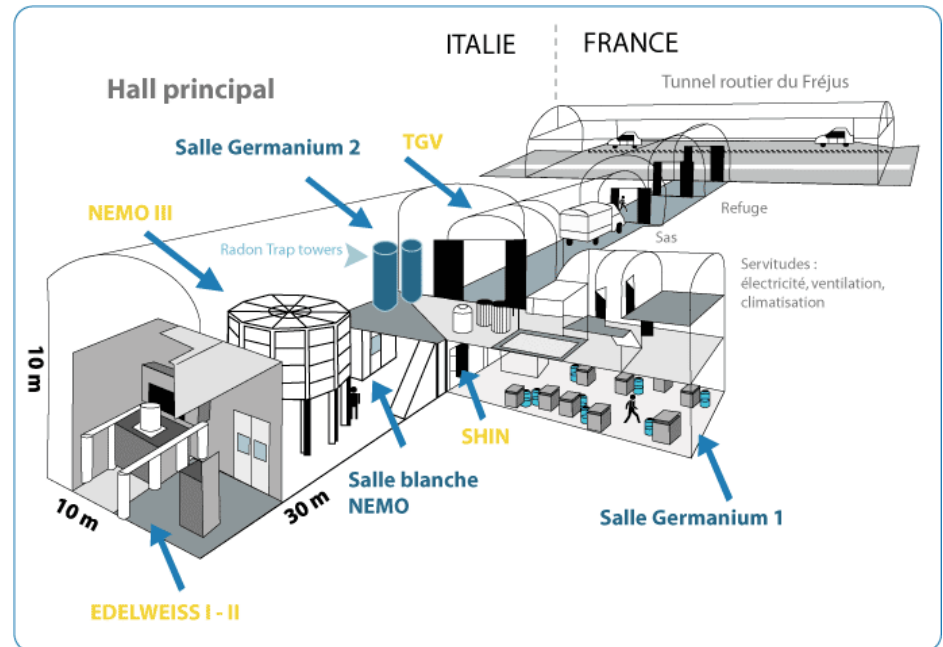


Expérience pour DEtecter Les WIMPs En Site Souterrain

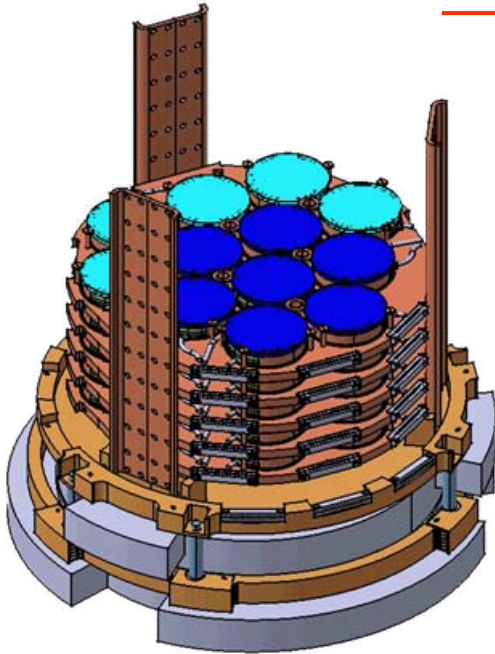
- CEA-Saclay DAPNIA/DRECAM
- CRTBT Grenoble
- CSNSM Orsay
- FZK/Univ. Karlsruhe
- JINR Dubna
- IAP Paris
- IPN Lyon

- **Laboratoire Souterrain de Modane**

- 1700 m depth under the Fréjus tunnel (4800 we)
- $4 \mu / \text{m}^2/\text{d}$ (10^6 less than at the surface)



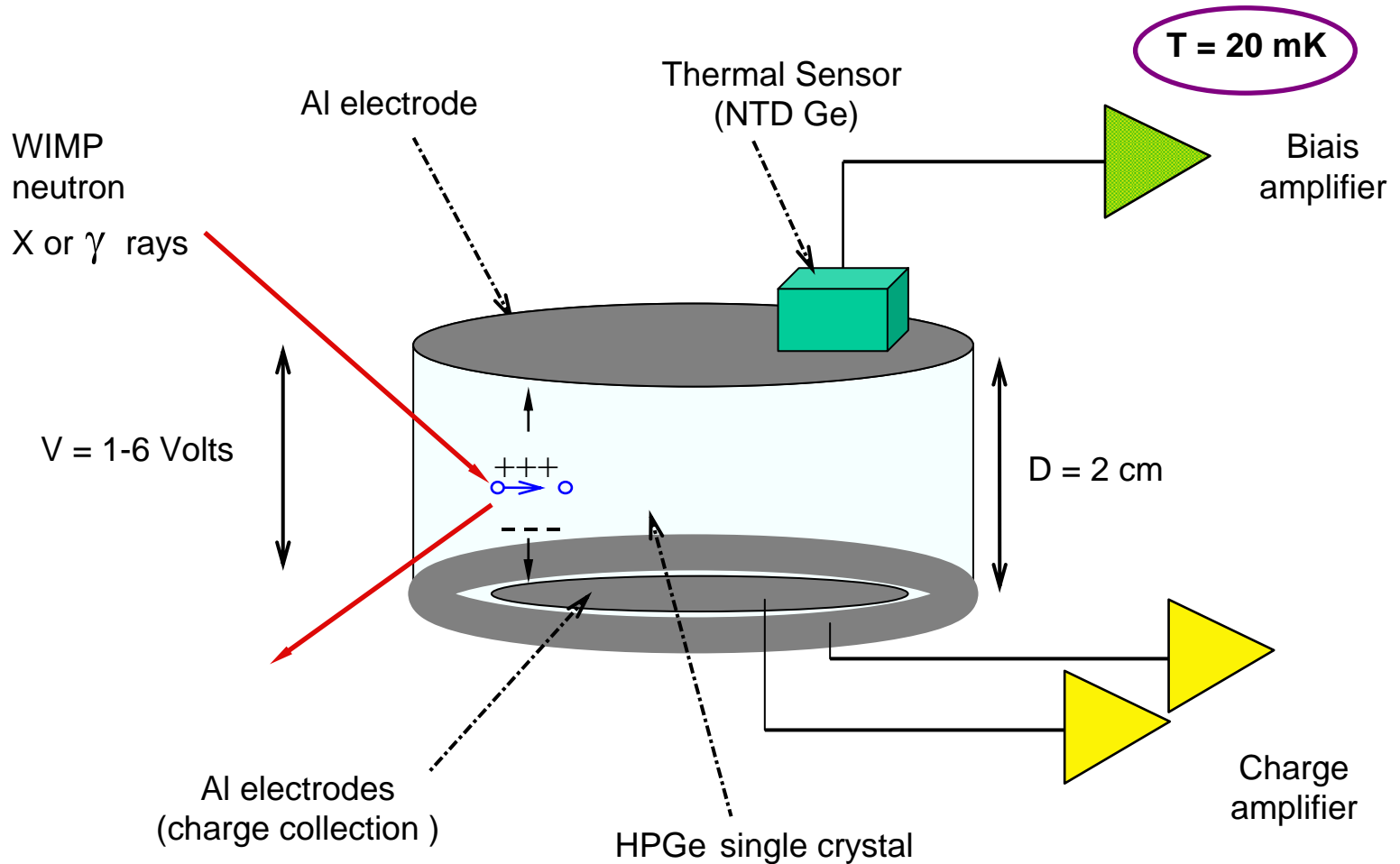
Edelweiss-II detectors



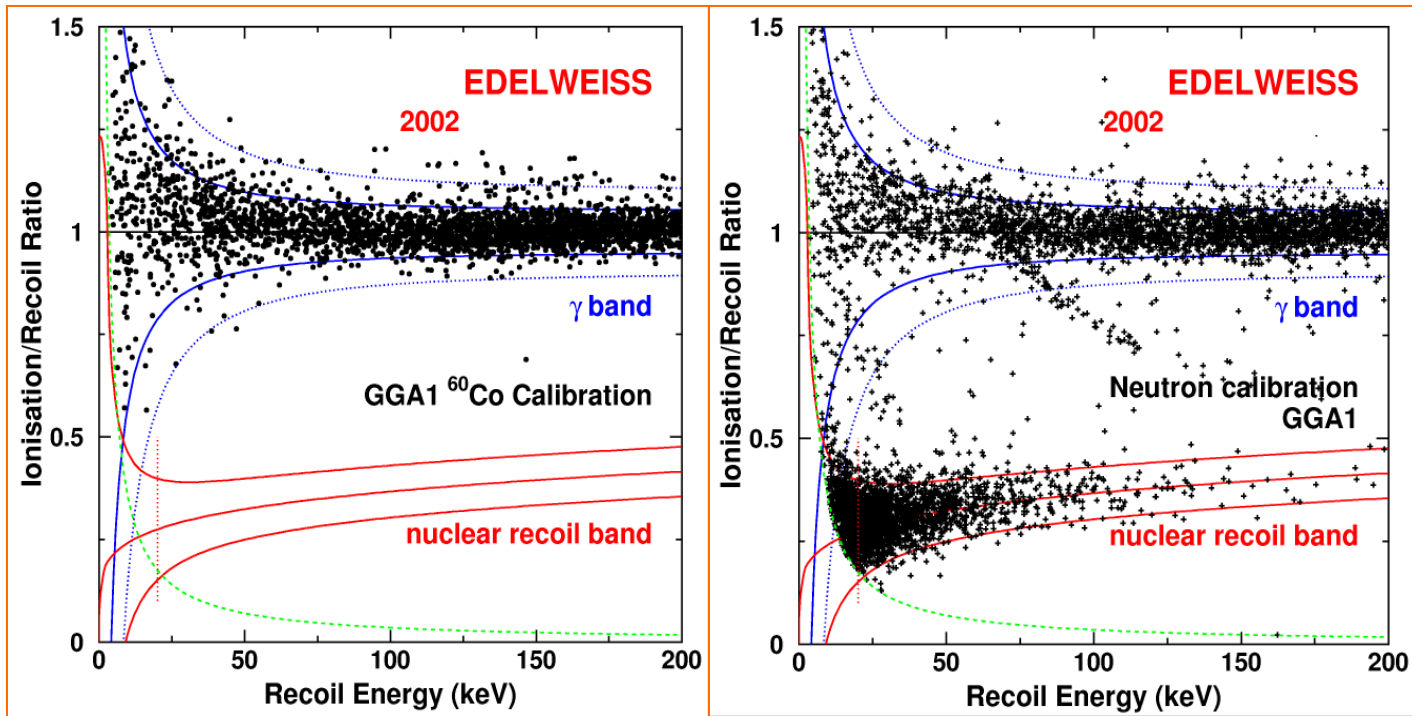
- 2 x 320g Ge/NTD with Cu-springs EDW-I holder
- 19 x 320g Ge/NTD with EDW-II holder and teflon clamp
- 2 x 320g Ge/NTD with Cu-springs EDW-II holder
- 1 x 50g heat and light IAS detector (Al_2O_3)
- 7 x 400g Ge/NbSi



Ionization-heat detectors



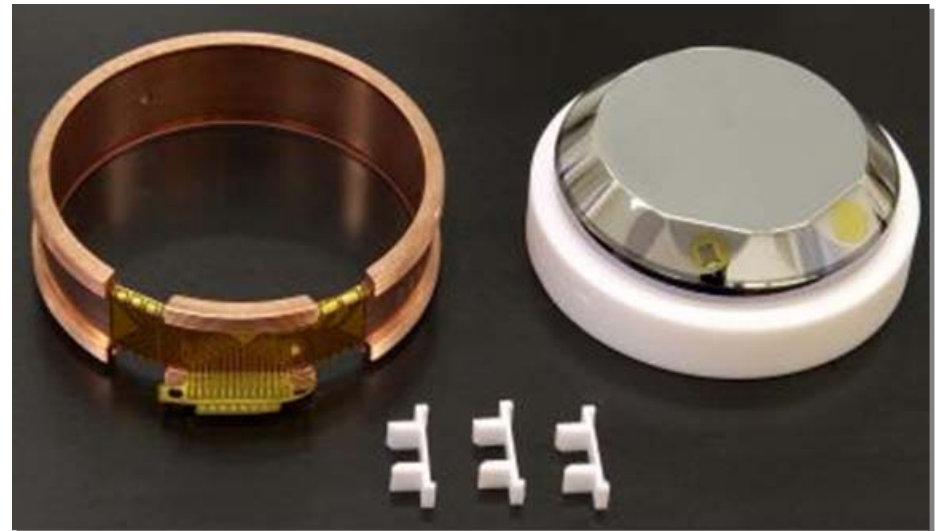
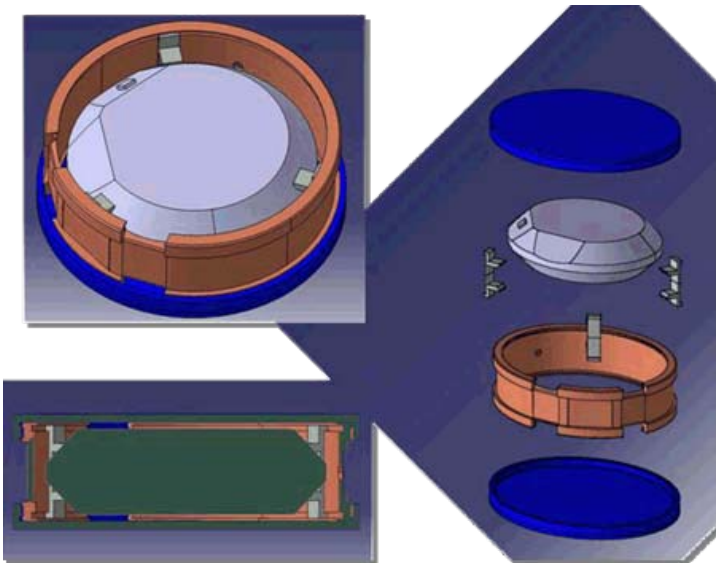
Rejection power



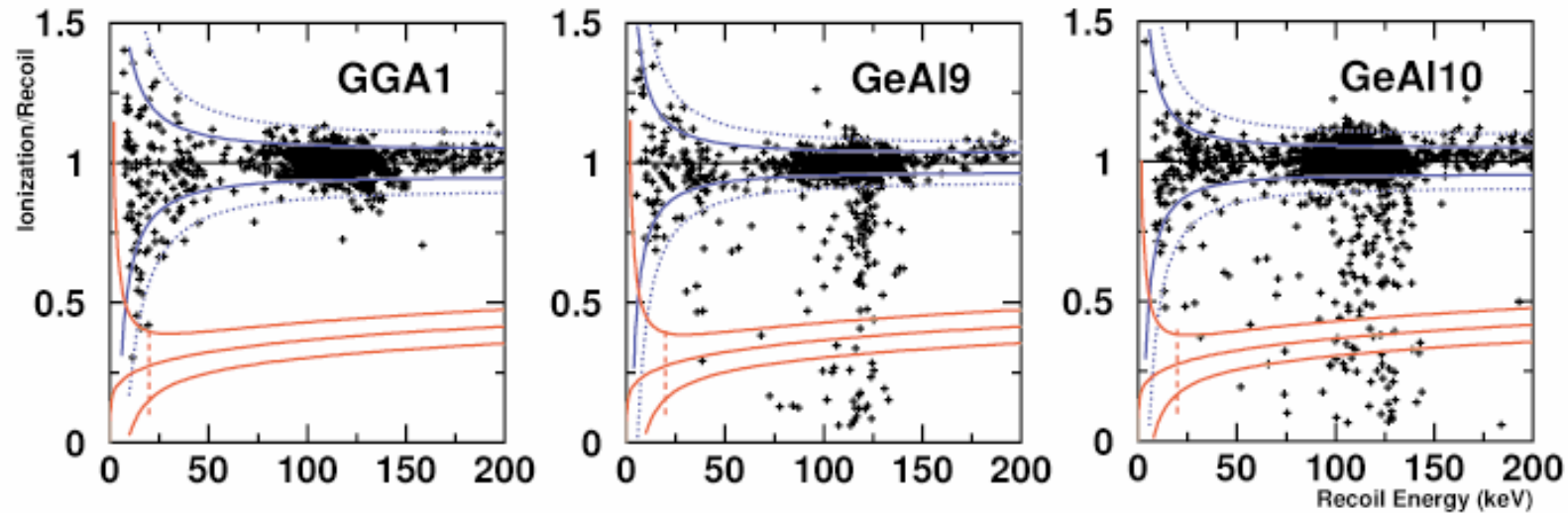
- ◆ Simultaneous measurement of ionization and heat => Evt per evt identification
 - ◆ $Q = E_{\text{ionisation}} / E_{\text{recoil}}$
 - $Q = 1$ for electronic recoil (ambient radioactivity)
 - $Q \approx 0.3$ for nuclear recoil (WIMP and neutron)
- ⇒ discrimination $\gamma/n > 99.9\%$ pour $E_r > 15\text{keV}$

Edelweiss-II Ge/NTD detectors

- Developed by CEA Saclay and Canberra
- Optimized NTD size in collaboration with LBNL for sub keV resolution
- New holder and connectors (Teflon and copper only)

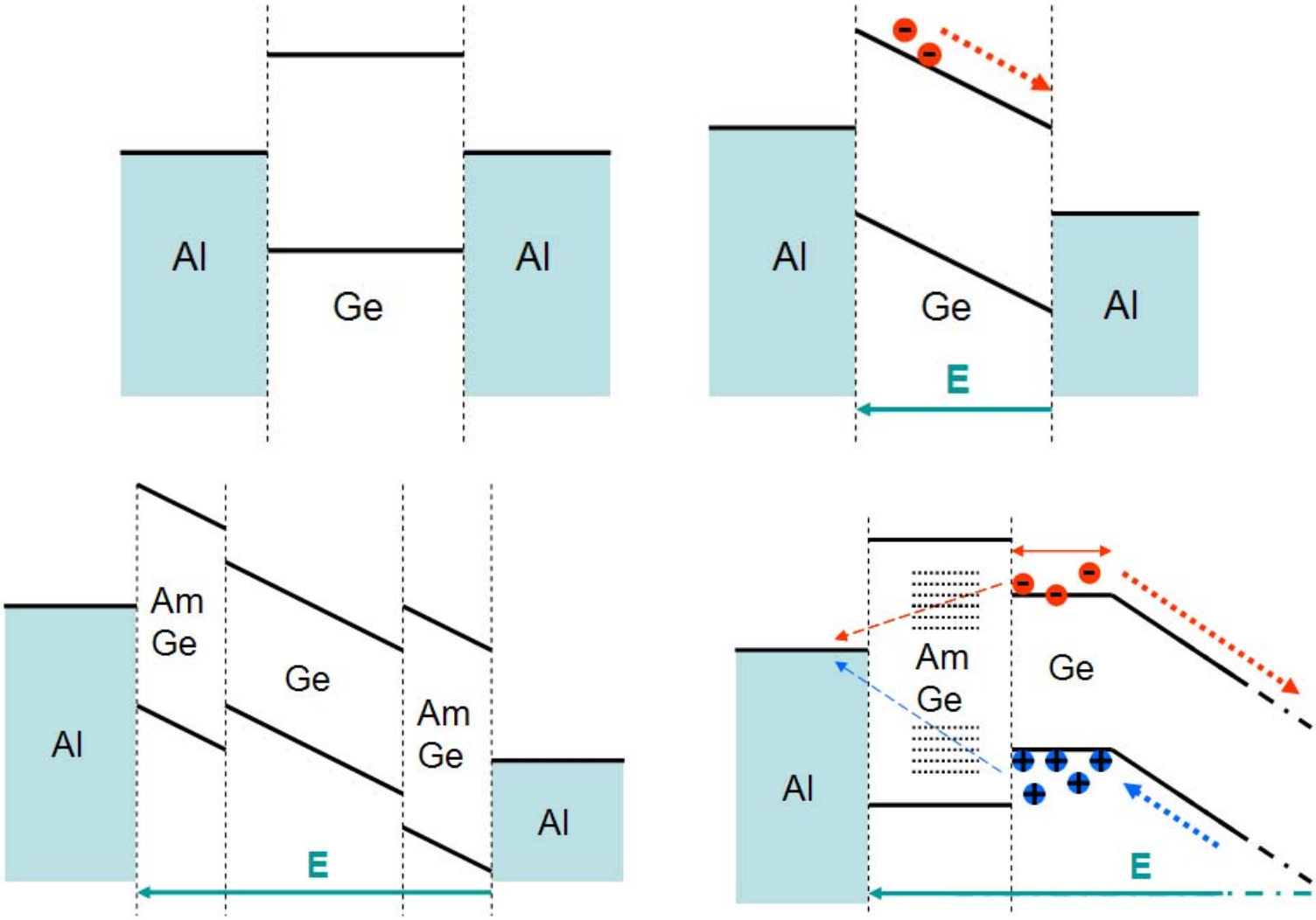


Incomplete charge collection



- Amorphous layers (Ge or Si) improve the charge collection
- At very low T and V : electric field is screened => diffusion phase
- Some carriers are trapped in the “wrong” electrode => incomplete collection

Effect of the amorphous layers

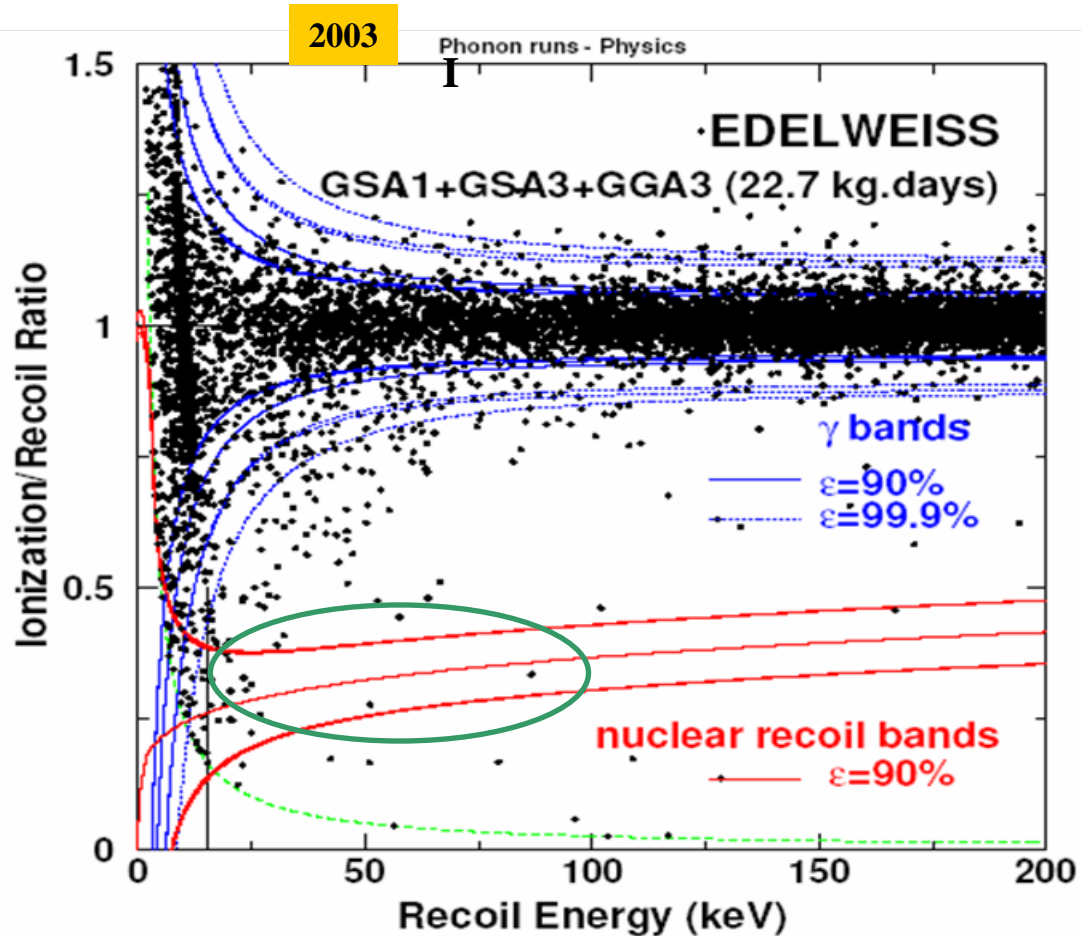


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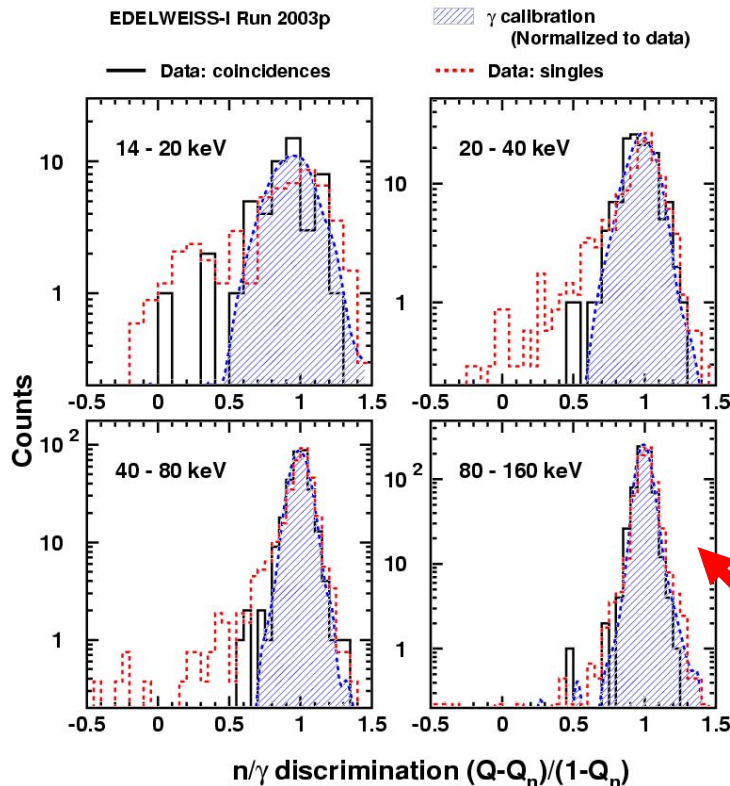
October 2006

Edelweiss-I data with phonon trigger

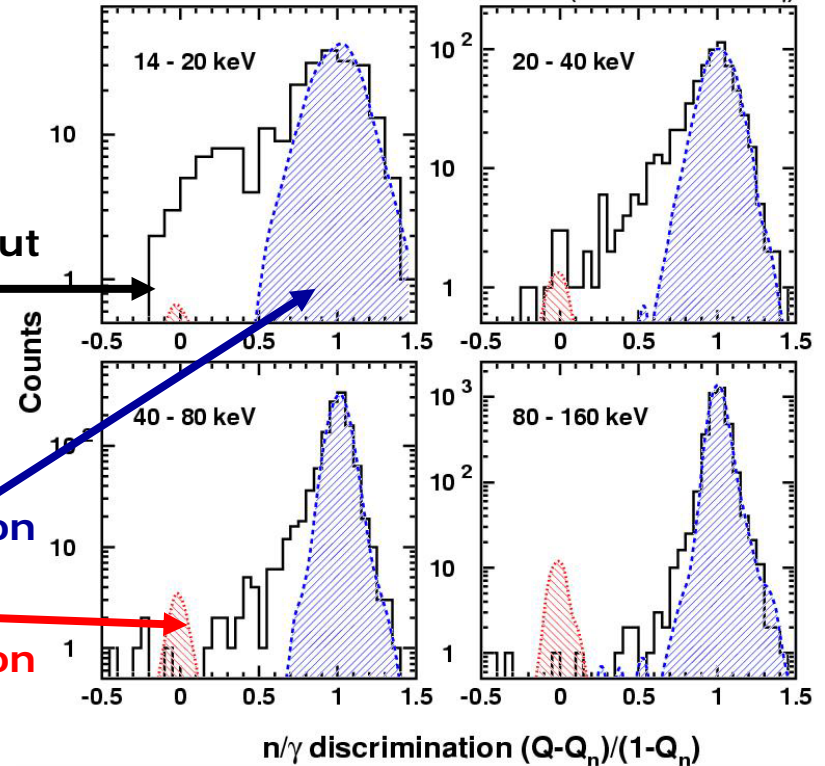


Surface events in Edw-I data

- Tale at low energy in the charge carrier collection profile



Data without source

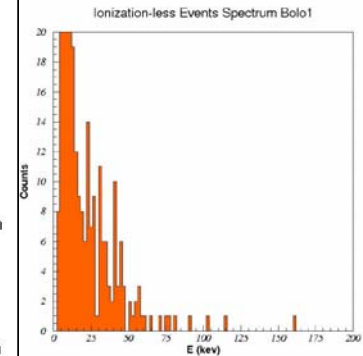
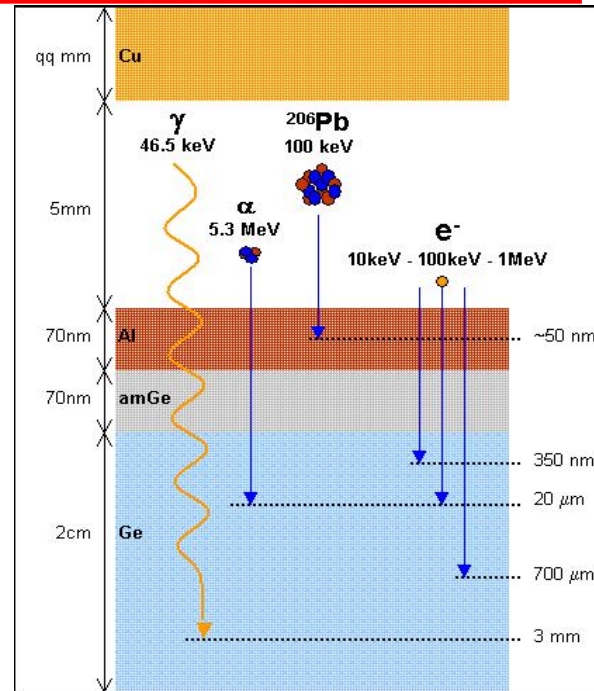
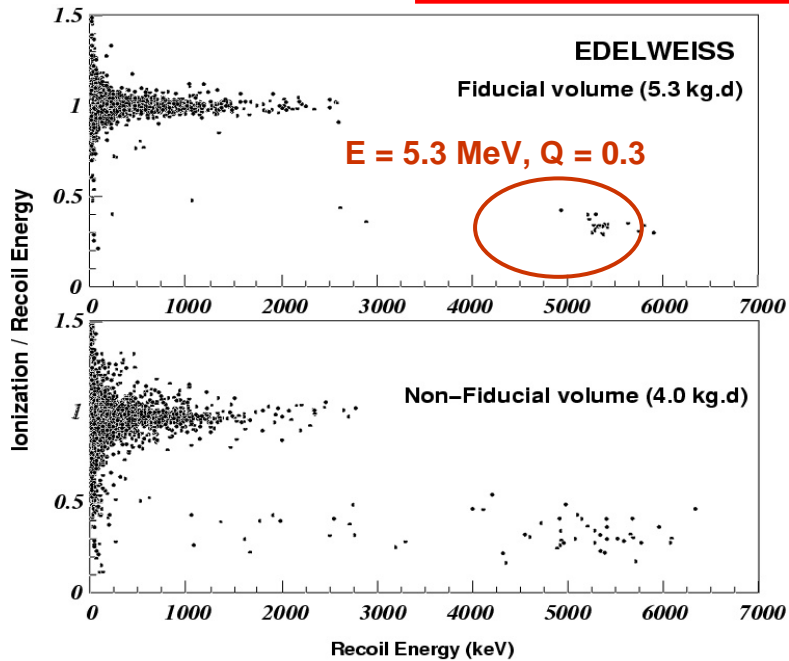


Coincidences between detectors:

less tale. Radiation does not penetrate the copper covers (~mm thick)

=> β on surface?

Surface contamination



α 's from ^{210}Po ($E_\alpha=5.3 \text{ MeV}$)

- $Q=0.3 \rightarrow \alpha$ decays near surfaces
- Rate $\sim 400 / \text{m}^2/\text{d}$
- As expected, non-fiducial part more exposed

^{210}Pb on Cu covers or Ge surfaces

- Should see Pb recoils and β 's

- No ^{206}Pb recoil peak at 100 keV observed as heat-only events: ^{210}Pb implanted in Cu, not Ge.
- Rate of $0.3 < Q < 1.0$ events at low energy consistent with expected surface β 's
- does not exclude contribution from ^{14}C
- By removing Cu between detectors, these events should disappear, or ID by coincidences

Surface events suppression

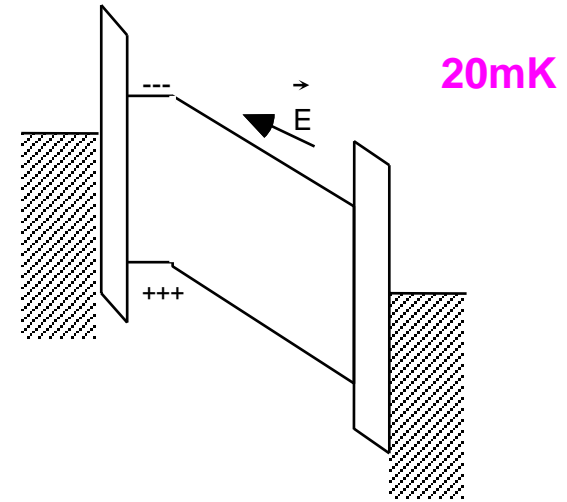
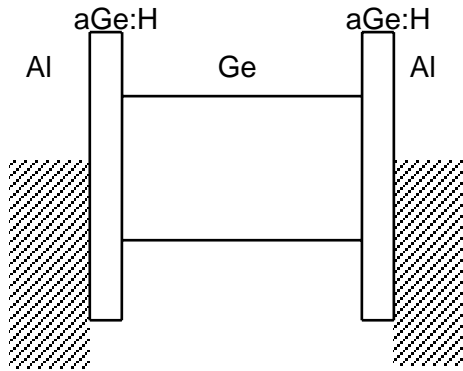
- ◆ Initial effort : improve the copper treatment (Rn contamination study) and reduce the surface exposure to radon
- ◆ Passive rejection : improve the charge collection for surface event
 - Physics of the Ge and Si amorphous sublayer
 - Detectors with thick electrodes
- ◆ Active rejection : identification of the surface events
 - Interleaved electrodes

localization of the event

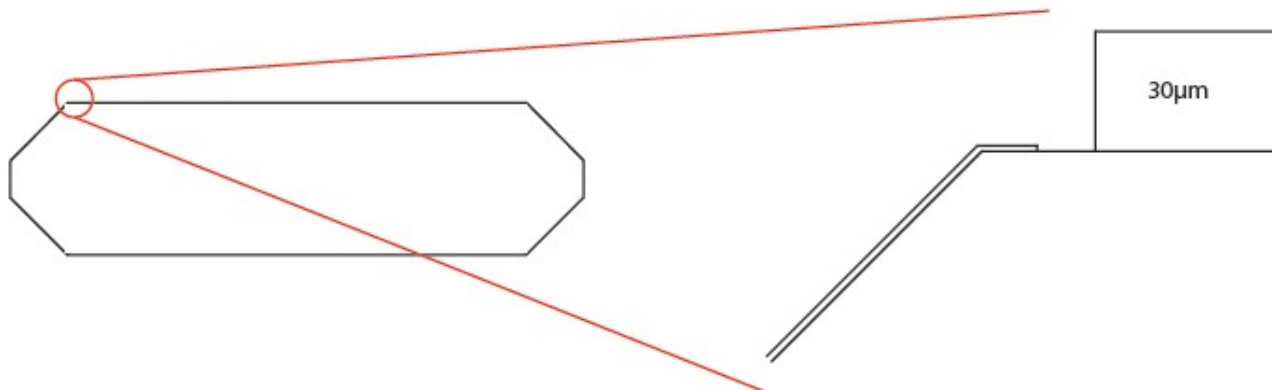
 - Pulse shape analysis of the charge signals
 - Detectors sensitive to athermal phonons ⇒ Ge/NbSi detectors

Passive protection

- Amorphous layers: $\text{Al} / \text{aGe:H} / \text{cGe} / \text{aGe:H} / \text{Al} \Rightarrow \text{GGA}$

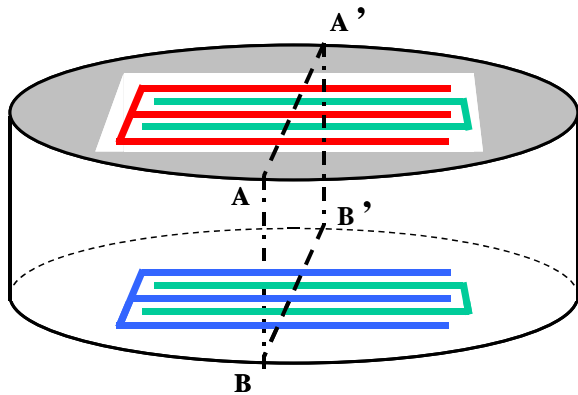


- Thick electrodes (high entrance window)

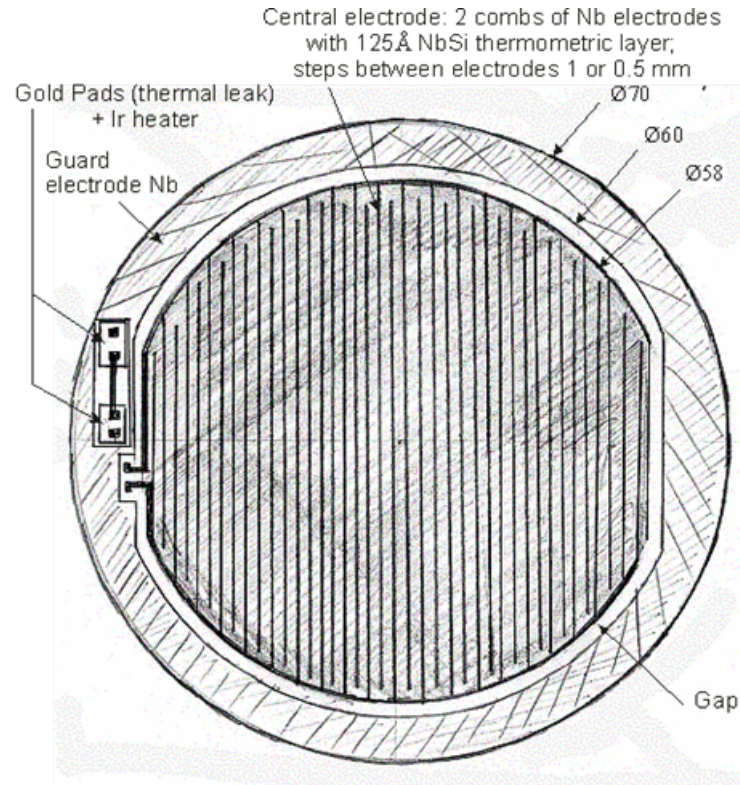


Interleaved electrodes design

Preliminary studies and current developments



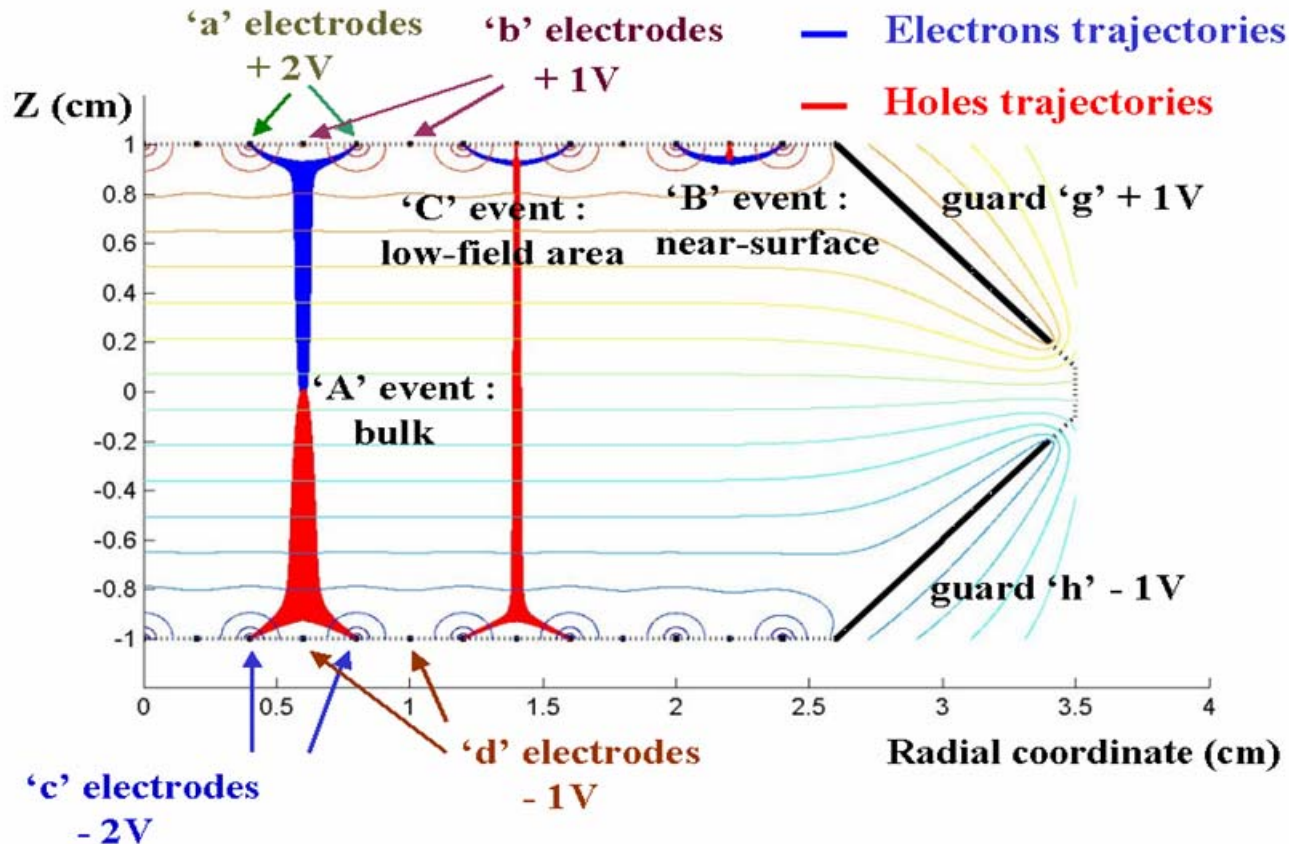
Schematics of detector fitted with interleaved collection electrodes: colors correspond to different voltage biases



Actual design

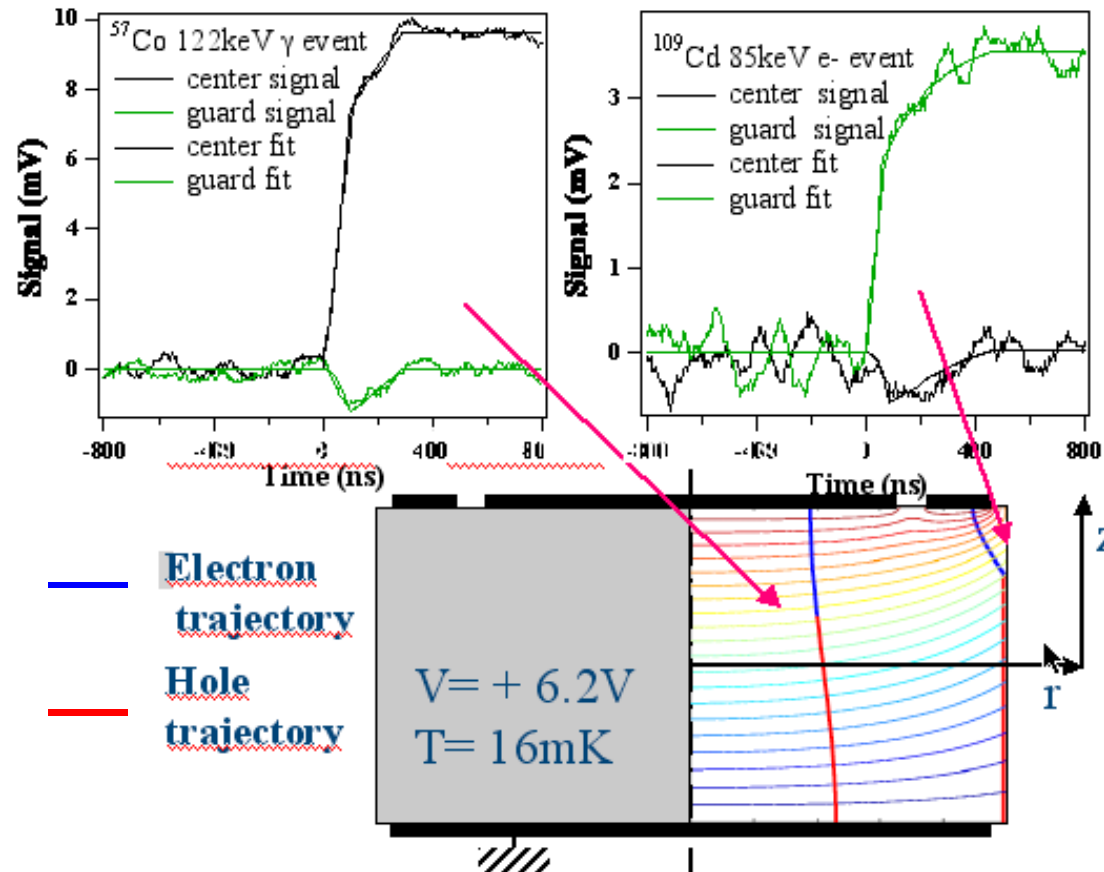
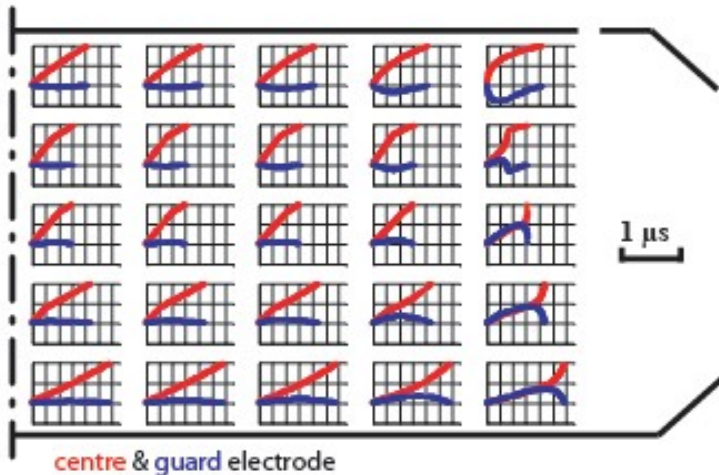
Simulation studies

Carrier trajectories and event populations in detector fitted with interleaved collection electrodes

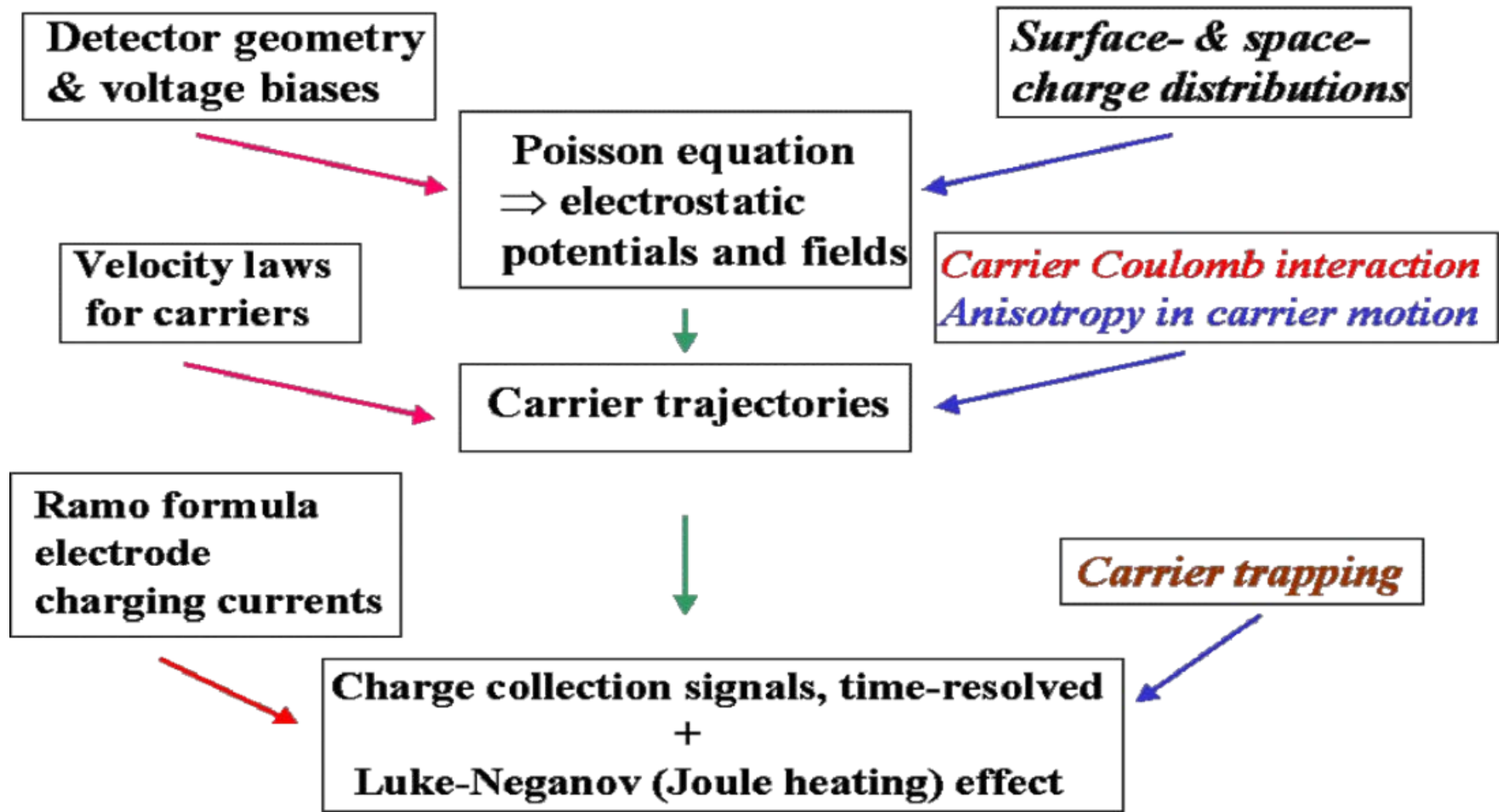


Localization by ionization shape analysis

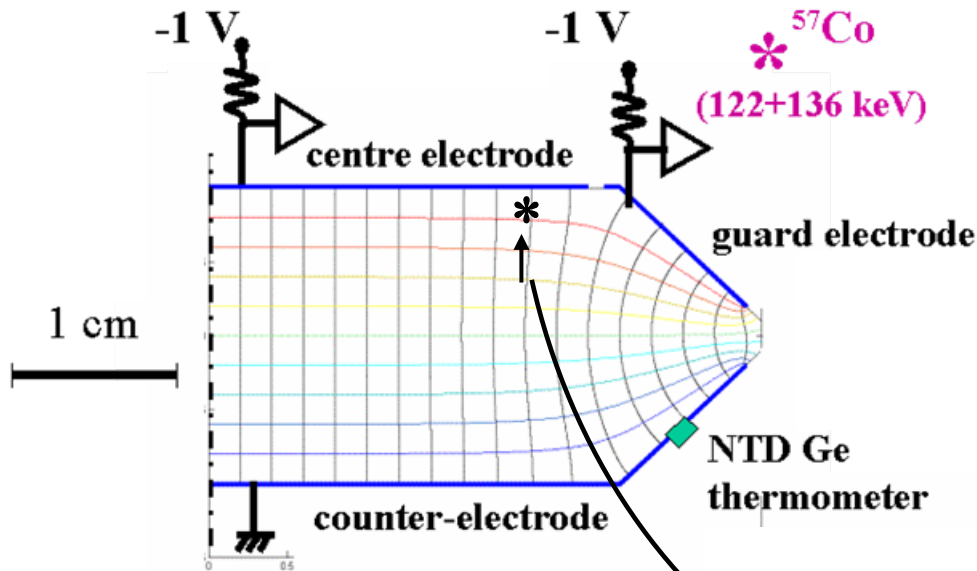
- Time-resolved charge measurement (with HEMT?)
- Comparaison with a set of simulated pulses



Code for ionization signal simulation

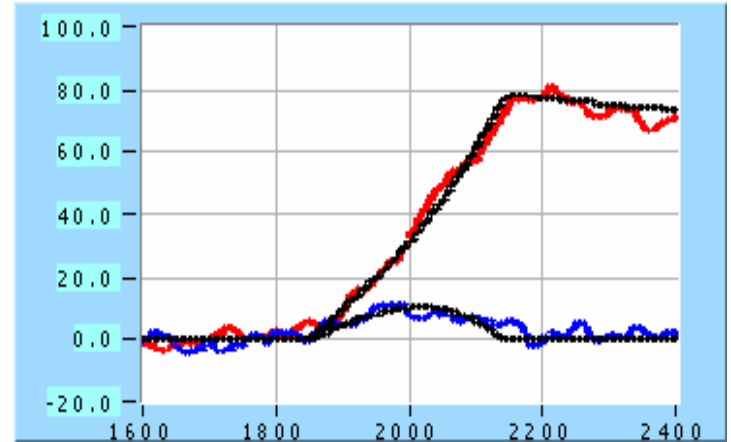


Test at LSM on a 320g Edw-I detector



Experimental setup
(-1 V collection voltage)

Event location



1000 ns

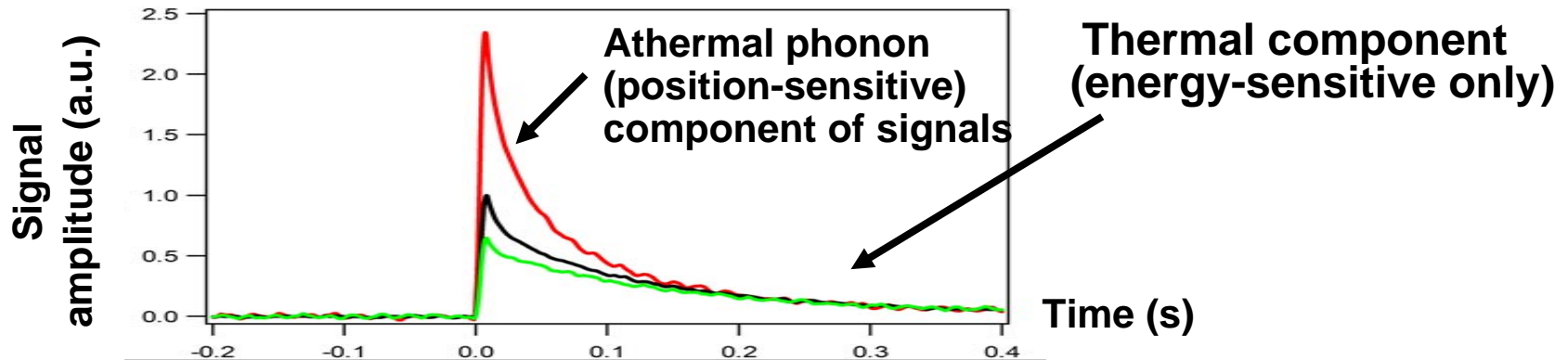
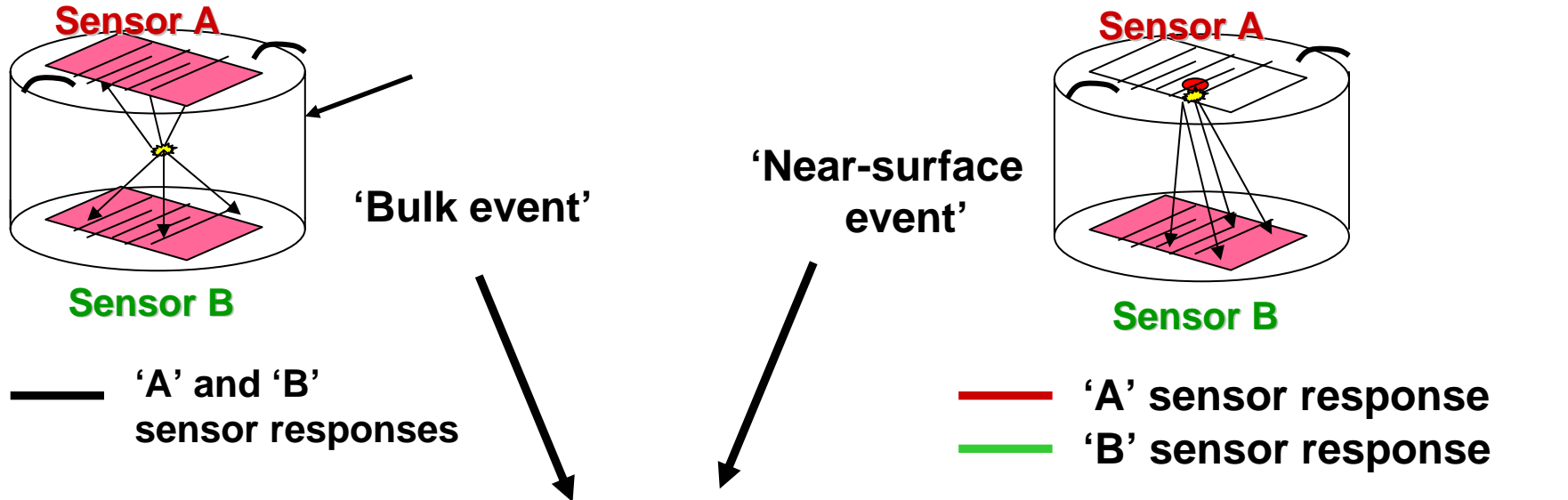
Near-surface, 122 keV γ event:

centre electrode signal in red
guard electrode signal in blue
best fit simulation in black

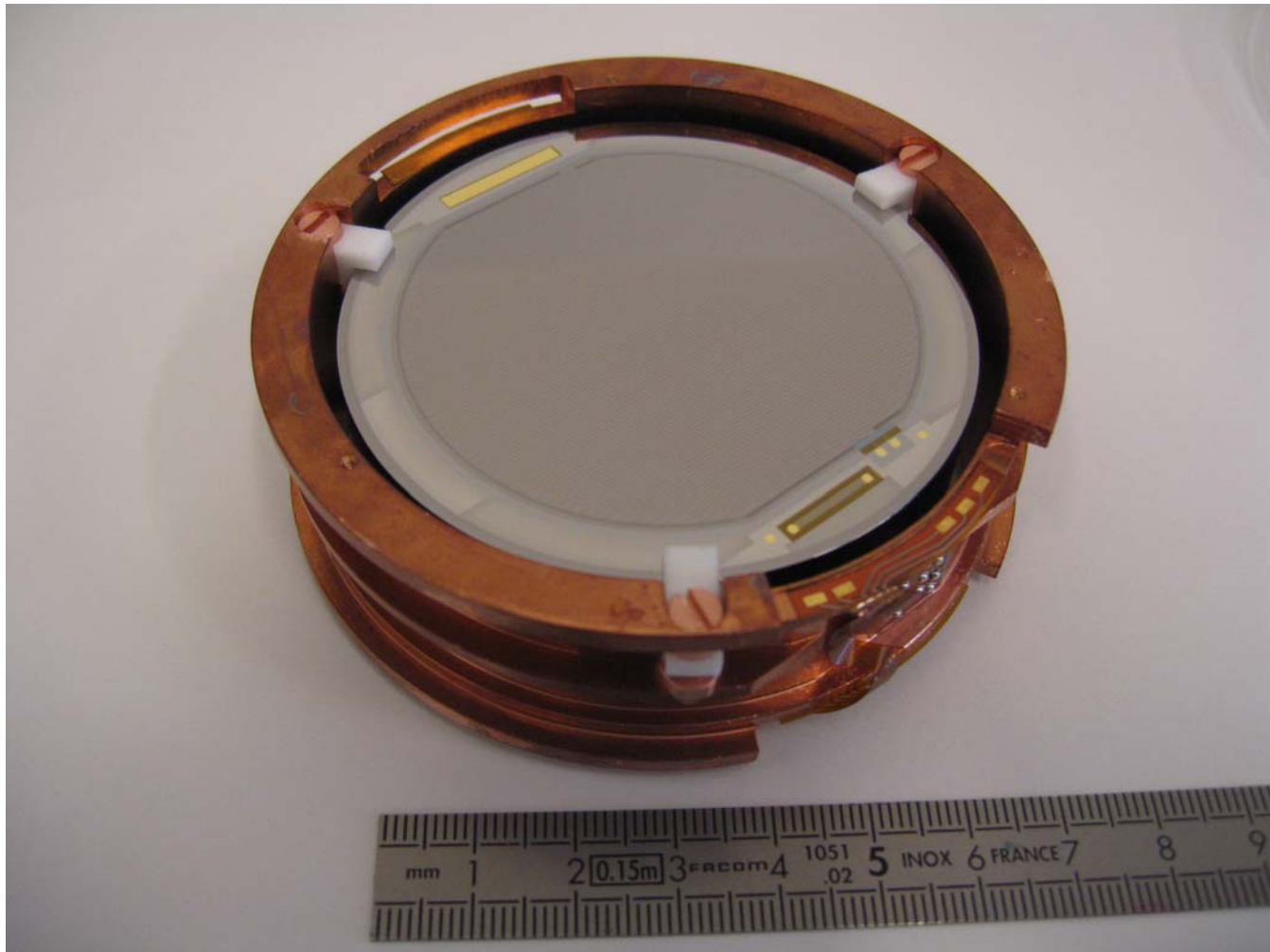
Due to electronic noise, surface event rejection by pulse-shape analysis is limited in practice to high-energy events only ($> \approx 50$ keV e.e.)

Ge detectors with NbSi sensors

Surface event discrimination: Nb-Si thin films as athermal phonon sensors



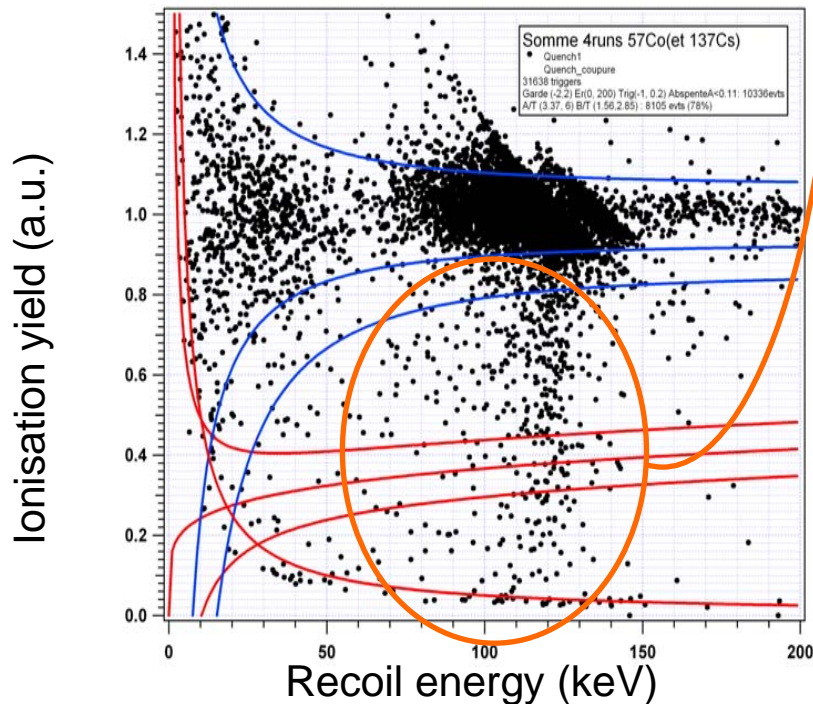
400g Ge detector with NbSi sensors



200g Ge detector with NbSi sensors in the Edw-I set-up at LSM

^{57}Co γ source

(a) Ionization yield vs. recoil energy
(thermal component of heat signals only):
note the large population of surface
events of poor charge collection



(b) With the proper cuts in the
athermal component of phonon
signals to remove surface events

